

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Tetsuya NAKAI	06/30/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SUMCO CORPORATION
<b>Street Address:</b>	2-1, Shibaura 1-chome, Minato-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12822323
<b>CORRESPONDENCE DATA</b>	
Fax Number: (703)716-1180 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 703-716-1191 Email: gbpatent@gbpatent.com Correspondent Name: Greenblum & Bernstein, P.L.C. Address Line 1: 1950 Roland Clarke Place Address Line 4: Reston, VIRGINIA 20191	
<b>ATTORNEY DOCKET NUMBER:</b>	P38577
<b>NAME OF SUBMITTER:</b>	William S. Boshnick
Total Attachments: 2 source=P38577_ASSG#page1.tif source=P38577_ASSG#page2.tif	

OP \$40.00 12822323

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**PATENT**  
**REEL: 024947 FRAME: 0628**

ASSIGNMENT

WHEREAS, Tetsuya NAKAI citizens of Japan, whose post office address is c/o SUMCO CORPORATION, 2-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

## METHOD FOR MANUFACTURING SIMOX WAFER AND SIMOX WAFER

for which he has executed an application for Letters Patent of the United States which was filed in the United States Patent and Trademark Office on June 24, 2010 and awarded Application No. 12/822,323.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043, Andrew M. Calderon, Reg. No. 38,093, William E. Lyddane, Reg. No. 41,568 and William S. Boshnick, Reg. No. 44,550, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. \_\_\_\_, filed \_\_\_\_ ) the filing date and application number of said application when known.

AND WHEREAS, SUMCO CORPORATION, a corporation organized and existing under the laws of the State of Japan, whose post-office address is 2-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee

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acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by Tetsuya NAKAI, this 30<sup>th</sup>  
day of June 2010, at c/o SUMCO CORPORATION, 2-1, Shibaura  
1-chome, Minato-ku, Tokyo, Japan.

First Witness:

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(Name)

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(Date)

Tetsuya Nakai  
Tetsuya NAKAI

Second Witness:

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(Name)

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(Date)

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